MITSUBISHI

type A2CCPU(P21/R21), A2CCPU-DC24V, A2CCPUC24(-PRF), A2CJCPU(S3)

User's Manual (Hardware)



Mitsubishi Programmable Controller

SAFETY PRECAUTIONS

(Read these precautions before using.)

When using Mitsubishi equipment, thoroughly read this manual and the associated manuals introduced in this manual. Also pay careful attention to safety and handle the module properly.

These precautions apply only to Mitsubishi equipment. Refer to the CPU module user's manual for a descriprion of the PC system safty precautions.

These • SAFETY PRECAUTIONS • classifive the safety precautions into two categories: "DANGER" and "CAUTION".



Depending on circumestances, procedures indicated by **CAUTION** may also be linked to serious results.

In many case, it is important to follow the directions for usage.

Store this manual in a safe place so that you can take it out and read it whenever necessary. Always forward it to the end user. [System Design Precautions]

•	 Safety circuits should be installed external to the programmable controller to ensure that the system as a whole will continue to operate safely in the event of an external power supply malfunction or a programmable controller failure. Erroneous outputs and operation could result in an accident. 1) The following circuitry should be installed outside the programmable controller:
	Interlock circuitry for the emergency stop circuit protective circuit, and for reciprocal operations such as forward/reverse, etc., and interlock circuitry for upper/lower positioning limits, etc., to prevent machine damage. 2) When the programmable controller detects an abnormal condition,
	 processing is stopped and all outputs are switched OFF. This happens in the following cases: When the power supply module's over-current or over-voltage protection
	 device is activated. When an error (watchdog timer error, etc.) is detected at the PC CPU by the self-diagnosis function.
	 Some errors, such as input/output control errors, cannot be detected by the PC CPU, and there may be cases when all outputs are turned ON when such errors occur. In order to ensure that the machine operates safely in such cases, a failsafe circuit or mechanism should be provided outside the programmable controller. Refer to the CPU module user's manual for an example of such a failsafe circuit. 3) Outputs may become stuck at ON or OFF due to an output module relay or
	transistor failure. An external circuit should therefore be provided to monitor output signals whose incorrect operation could cause serious accidents.
•	A circuit should be installed which permits the external power supply to be switched ON only after the programmable controller power has been switched ON. Accidents caused by erroneous outputs and motion could result if the external power supply is switched ON first.
•	When a data link communication error occurs, the status shown below will be established at the faulty station. In order to ensure that the system operates safely at such times, an interlock circuit should be provided in the sequence program (using the communication status information). Erroneous outputs and operation could result in an accident. 1) The data link data which existed prior to the error will be held.
	 All outputs will be switched OFF at MELSECNET (II, /B, /10) remote I/O stations.
	 At the MELSECNET/MINI-S3 remote I/O stations, all outputs will be switched OFF or output statuses will be held, depending on the E.C. mode setting.
	For details on procedures for checking faulty stations, and for operation statuses when such errors occur, refer to the appropriate data link manual.

[System Design Precautions]

 Do not bundle control lines or communication wires together with main circuit or power lines, or lay them close to these lines. As a guide, separate the lines by a distance of at least 100 mm, otherwise malfunctions may occur due to noise.

[Cautions on Mounting]



DANGER

• Switch off the external power supply before staring installation and wiring work.

Failure to do so could result in electrical shocks and equipment damage.

 After installation and wiring is completed, be sure to attach the terminal cover before switching the power ON and starting operation.
 Failure to do so could result in electrical shocks.



[Cautions on Startup and Maintenance]

 Do not touch terminals while the power is ON. This will cause malfunctions.
 Make sure that the battery is connected properly. Do not attempt to charge or disassemble the battery, do not heat the battery or place it in a flame, and do not short or solder the battery. Incorrect handling of the battery can cause battery heat generation and ruptures which could result in fire or injury.
• Switch the power off before cleaning or re-tightening terminal screws. Carrying out this work while the power is ON will cause failure or malfunction of the module.
 Read the manuals carefully and thoroughly confirm safety before performing online operations with a peripheral device connected to the CPU module in the RUN state (especially program changes, forced output, and changes in operation status). Incorrect operation could result in machine failure and injury.

• Do not disassemble or modify any module. This will cause failure, malfunction, injuries, or fire.

[Disposal Precautions]



[Transportation Precautions]



MEMO

REVISIONS

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Apr., 1994	IB (NA) 66475-A	First edition
Mar.,1996	IB (NA) 66475-B	Overall revision
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		SAFETY CAUTIONS
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		SAFETY CAUTIONS

*The manual number is given on the bottom left of the back cover.

INTRODUCTION

Thank you for choosing the Mitsubishi MELSEC-A Series of General Purpose Programmable Controllers. Please read this manual carefully so that the equipment is used to its optimum. A copy of this manual should be forwarded to the end User.

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This manual describes precautions for handling of the A2CCPU(P21/R21), A2CCPU-DC24V, A2CCPUC24(-PRF), and A2CJCPU(S3) (hereinafter referred to as the "A2C" unless otherwise required to identify), wiring of the A2C I/O modules, and error codes.

Refer to the following manuals as required:

[Detailed manuals]

- A2CCPU(P21/R21), A2CCPU-DC24V, A2CCPUC24(-PRF), A2CJCPU User's Manual (IB-66545)
- A2CJCPU User's(S3) Manual (IB-66462)

These manuals describe system configurations, specifications and handling for the A2C.

[Related manuals]

 MELSECNET and MELSECNET/B Data Link System Reference Manual (IB-66350)

This manual describes performance, functions, and programming methods of the MELSECNET (II) using an A2CCPUP21/R21.

 Computer Link/Multidrop Link Module User's Manual (Computer Link Function/Printer Function) (SH-3511)

This manual describes specifications, handling, and transmission protocols of the A2CCPUC24(-PRF) computer link. Refer to the A2CCPUC24(-PRF) User's Manual for the use of the A2CCPUC24(-PRF).

ACPU Programming Manual (Fundamentals) (IB-66249)

This manual describes programming methods, device names, parameters, program types, and memory area configuration required to create programs.

ACPU Programming Manual (Common Instructions) (IB-66250)

This manual describes sequence, basic, and application instructions, and the use of microcomputer programs.

1. ENVIRONMENTAL SPECIFICATIONS

This product has been designed to be installed in the following environmental conditions.

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Please place the product at places of where environmental conditions satisfies the specifications.

Item	Specification										
Operating ambient temperature	0 to 55 °C	0 to 55 °C									
Storage ambient temperature	-20 to 75 °C	-20 to 75 °C									
Operating ambient humidity	10 to 90%R	10 to 90%RH, no dewing									
Storage ambient humidity	10 to 90%R	10 to 90%RH, no dewing									
		For intermitte	ent vibration	-							
		Frequency	Acceleration	Amplitude	Sweep count						
	Conforms to *JIS B	10 to 57Hz		0.075 mm (0.003 in.)							
Vibration resis- tance	3501, IEC 1131-2	57 to150Hz	9.8 m/s ² {1G}		10 times each in						
		For continuo	X, Y and Z directions								
		Frequency	Acceleration	Amplitude	(80						
		10 to 57Hz		0.035 mm (0.0014 in.)	minutes)						
		57 to150Hz	4.9 m/s ² {0.5G}								
Shock resistance	Conforms t (147 m/s ² (o JIS B 3501, 15G) x 3 times	IEC 1131-2 a in 3 directions)	I	· · · · · · · · · · · · · · · · · · ·						
Operating atmosphere	To be free	of corrosive ga	1505								
Altitude	Up to 2,000	0 m (6561.68 f	t.)								
Installation site	Inside a co	ntrol cabinet		· · · · · · · · · · · · · · · · · · ·							
Overvoltage category	II or lower										
Degree of contamination	No greater	than 2									

REMARK

* JIS: Japanese Industrial Standard

2. MODULE SPECIFICATIONS

2.1 Power Supply Modules

This section describes the power supply units for the A2CJCPU (S3), A2C I/O units, remote terminal block I/O units, and remote connector I/O units. Specifications of power supply modules are shown in the following table.

	•	Specifi	cations			
	tem	A66PC	A2CJ66P			
Rated input voltage			00 to 240 VAC / -15 %			
Rated input frequer	су	50 / 60 Hz ±3 %				
Max. input apparen	l power	110 VA or lower				
Inrush current		20 AP / 20 AP max. 8 ms				
*1 Rated output cur- rent	24 VDC ± 5 %	0.6 A				
*2 Overcurrent pro- tection	24 VDC	1.25 A ± 20 % (Inverted L-type drooping) characteristic	2 A ± 30 % (Invertde L-type drooping) characteristic			
*3 Overvoltage pro- tection	24 VDC	35 VDC ±10 %				
Efficiency		65% or higher				
Insulation with- stand voltage	Between primary and 24 VDC	1500 VAC				
Noise immunity		IFC 801-4, 2 KV				
Power indication		Power LED indication				
Terminal screw size)	M3.5 × 7				
Applicable wire size	•	AWG16 to 22				
Applicable tightenig	torque	83 to 113 N⋅cm (8.5 to 11.5 kg	·cm)			
External dimension	mm (inch)					
Weight kg (lb)		0.66 (1.45) 0.3 (0.66)				
Allowable momenta	ry power failure time	Within 20 ms				

POINTS

*1 The rated output current varies according to the ambient temperature, as shown below :



*2 If a current larger than that stated in the specifications flows in the 24 VDC circuit, the overcurrent protection function breaks the circuit and stops the system. The LED indicators of the power supply unit go OFF due to the voltage drop.

When the overcurrent protection function has been actuated, first eliminate the cause - for example: insufficient current capacity or short circuit - and then start up the system again. When the current value is normal, the system will execute an initial start.

*3 When an A66PC is being used and an overcurrent of 31.5 to 38.5 V is applied to the 24 VDC circuit, the overcurrent protection device shuts down the circuit and stops the system. The power supply module's LED indicators go OFF. To restart the system, switch the power ON after it has been OFF for about three minutes; the system will start up by executing an initial start. If the system fails to start up and the LED indicators remain OFF, the power supply unit has to be replaced.

Digital I/O Modules 2.2

2.2.1 Input modules

	Турө					Operatin	g Voltage	Maximum	
Model		No. of Points	Rated Input Voltage	Input Current	Insulation Withstand Voltage		OFF Voltage	Simultaneous Input Points (Percentage Simultaneously ON)	
AX11C	AC input	32	100 to 120 VAC, 50/60 Hz	6 mA	1.5 KV	80 VAC or higher	30 VAC or lower	75% (110 VAC)	
AX21C	AC input	32	200 to 240 VAC, 50/60 Hz	5 mA	1.5 KV	80 VAC or higher	30 VAC or lower	80% (200 VAC and 60 HZ)	
AJ35TB1-16A *2	AC input	16	100 to 120 VAC, 50/60 Hz	6 mA	1.5 KV	80 VAC or higher	30 VAC or lower	100% (110 VAC)	
AX31C	AC/DC input	32	12/24 VAC, 50/60 Hz 12/24 VDC	4/8.5 mA	500 V	7 VAC/VDC or higher	2.5 VAC/VDC or lower	75% (26.4 VAC)	
AX41C	DC input (sink type)	32	12/24 VDC	3/7 mA	500 V	8 VDC or higher	4 VDC or lower	100% (26.4 VDC)	
AJ35TB3-8D *2	DC input (sink type)	8	24 VDC	7 mA	500 V	14 VDC or higher	6 VDC or lower	100% (26.4 VDC)	
AX81C	DC input (sink/source)	32	12/24 VDC	3/7 mA	500 V	8 VDC or higher	4 VDC or lower	100% (26.4 VDC)	
AJ35TB1-16D	DC input (sink/source)	16	24 VDC	7 mA	500 V	14 VDC or higher	6 VDC or lower	70% (26.4 VDC)	
AJ35TB2-16D	DC input (sink/source)	16	24 VDC	7 mA	500 V	14 VDC or higher	6 VDC or lower	100% (26.4 VDC)	
AJ35TC1-32D *1	DC input (sink/source)	32	24 VDC	5 mA	500 V	17.5 VDC or higher	6 VDC or lower	85% (26.4 VDC)	

Specifications of input modules are shown in the following table.

For all models - Isolation: photocoupler isolation, Input display: LED display *1: A 40-pin connector is used for external connection.

*2: Only usable with A2CJCPU-S3

Max. Resp	onse Time	1						
OFF to ON	ON to OFF	Field Wiring	Applicable Wire Size	Points/ Common	Noise Immunity	Internal Current Consumption (24 VDC)	No. of Stations Occupied	Power Supply Requirement
15 ms	30 ms	rminal		16	± 1.5 KV	0.056 A	4	
30 ms	55 ms	Terminal		16	± 1.5 KV	0.058 A	4	
15 ms	30 ms	Terminal		16	± 1.5 KV	0.050 A	2	
35 ms 30 ms	30 ms 30 ms	Terminal		16	± 500 V	0.056 A	4	
10 ms	10 ms	Terminal	0.75 to 2 mm ² AWG 14	16	± 500 V	0.055 A	4	
10 ms	10 ms	Termina!		8	± 500 V	0.069 A	1	SELV power
10 ms	10 ms	Terminal]	16	± 500 V	0.055 A	4	supply is required
10 ms	10 ms	Terminal		16	± 500 V	0.045 A	2	
10 ms	10 ms	Terminal]	16	± 500 V	0.045 A	2	
10 ms	10 ms	40-pin connector, Terminal	1	32	± 500 V	0.055 A	4	

Specifications of input modules are shown in the following table.

2-4

2.2.2 Output modules

	*	No. of	Rated Load Voltage	Max. Load Current	Insulation Withstand	Max. Output Response Time	
Model	Туре	Points	naleu Loau Vollage	max. Load Current	Voltage	OFF to ON	ON to OFF
AY13C		32	240 VAC, 24 VDC	2 A/pt, 4 A/com	1.5 KV	10 ms	12 ms
AJ35TB1A-8R *2		8	240 VAC, 24 VDC	2A/pt	1.5 KV	10 ms	12 ms
AJ35TB2-8R *2	Relay output	8	240 VAC, 24 VDC	2A/pt, 5A/com	1.5 KV	10 ms	12 ms
AJ35TB1-16R *2		16	240 VAC, 24 VDC	2A/pt, 5A/com	1.5 KV	10 ms	12 ms
AY23C	Triac output	32	240 VAC	0.3 A/pt, 1.4A/com	1.5 KV	1 ms	0.5 cycle + 1 ms
AY51C		32	12/24 VDC	0.3 A/pt, 7.2A/com	1.5 KV	2 ms	2 ms
AY61CE		32	5/12/24 VDC	1 A/pt, 4 A/com	1.5 KV	2 ms	10 ms
AY81C]	32	24 VDC	0.5 A/pt, 9.6 A/com	500 V	2 ms	2 ms
AJ35TB1A-8T *2	Transister output	8	24 VDC	0.3 A/pt	500 V	2 ms	2 ms
AJ35TB2-8T *2		8	5/12/24 VDC	0.5 A/pt	500 V	2 ms	2 ms
AJ35TB1-16T		16	24 VDC	0.1 A/pt, 1.6 A/com	500 V	2 ms	2 ms
AJ35TB2-16T	1	16	24 VDC	0.1 A/pt, 1.6 A/com	500 V	2 ms	2 ms
AJ35TC1-32T *1		32	24 VDC	0.1 A/pt, 2 A/com	500 V	2 ms	2 ms

Specifications of output modules are shown in the following table.

For all models - Isolation: photocoupler isolation, Output display: LED display

*1: A 40-pin connector is used for external connection.

*2: Only usable with A2CJCPU-S3

- (1) It is recommended to use a triac output module for a load with high frequency of switching, a large inductive load or a low power factor load. (Durability of relay output units is shortened by using with such types of load.)
- (2) Minimum ON time and OFF time of output units for inductive loads is one second.
- (3) When a counter or timer device including a DC/DC converter is used as a load for a transistor output unit of which the maximum load current is 0.1 A or 0.3 A, periodic rush current when or while the unit is turned ON may cause its malfunction if the unit is selected based on average load current. If such a load should be used, connect a resistor or inductance to it in series, or used an output module with higher maximum load current to reduce the effect of the rush current.



(4) Excess loads cannot be protected. Each load must be protected with an external fuse separately mounted.

Field Wiring	Applicable Wire Size	Points/ Common	Surge Suppression	Noise Immunity	External Power Supply		Internal Current Consumption	No of Stations
	5120	Common		miniamity	Current	Requirement	(24 VDC)	Occupied
Trminal		8	None	± 1.5 KV	0.184 A		0.09 A	4
Terminal		1	None	± 1.5 KV	0.045 A	SELV power	0.07 A	1
Terminal		8	None	± 1.5 KV	0.045 A	supply is required	0.07 A	1
Terminal		8	None	± 1.5 KV	0.09 A		0.075 A	2
Terminal		8	CR	± 1.5 KV			0.18 A	4
Terminal	0.75 to 2 mm ² AWG 14	32	Zener diode	± 1.5 KV	0.064 A		0.09 A	4
Terminal	AWG 14	8	Zener diode	± 1.5 KV			0.15 A	4
Trminal		32	Zener diode	± 500 V	0.017 A		0.10 A	4
Terminal		1	Zener diode	± 500 V		SELV power supply is	0.085 A	1
Terminal		8	Zener diode	± 500 V	- <u>-</u> -	required	0.07 A	1
Terminal		16	Zener diode	± 500 V			0.13 A	2
Terminal		16	Zener diode	± 500 V			0.13 A	2
40-pin connector, Terminal		32	Zener diode	± 500 V]	0.06 A	4

Specifications of input/output combined modules are shown in the following table.

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			Data d Immut	nput Input	Insulation	Operatin	g Voltage	Maximum Simultaneous input	
Model	Туре	No. of Points	Rated Input Voltage	Current	Withstand Voltage	ON Voltage	OFF Voltage	Points (Percentage Simultaneously ON)	
AX10Y10C	AC input	16	100 to 120 VAC	6 mA	1.5 KV	80 VAC or higher	30 VAC or lower	100% (110 VAC)	
AX10Y22C	AC input	16	100 to 120 VAC	6 mA	1.5 KV	80 VAC or higher	30 VAC or lower	60% (110 VAC)	
AJ35TB1-16AR *2	AC input	8	100 to 120 VAC	6 mA	1.5 KV	80 VAC or higher	30 VAC or lower	100% (110 VAC)	
AX40Y10C	DC input	16	12/24 VDC	3/7 mA	500 V	8 VDC or higher	4 VDC or lower	100% (26.4 VDC)	
AJ35TB1-16DR *2	DC input	8	24 VDC	7 mA	500 V	14 VDC or higher	6 VDC or lower	100% (26.4 VDC)	
AJ35TB1-16DT *2	DC input	8	24 VDĊ	7 mA	500 V	14 VDC or higher	6 VDC or lower	100% (26.4 VCD)	
AX40Y50C	DC input (sink type)	16	12/24 VDC	3/7 mA	500 V	8 VDC or higher	4 VDC or lower	60% (26.4 VDC)	
AX80Y10C	DC input (sink/source)	16	12/24 VDC	3/7 mA	500 V	8 VDC or higher	4 VDC or lower	100% (26.4 VDC)	
AX80Y80C	DC input (sink/source)	16	12/24 VDC	3/7 mA	500 V	8 VDC or higher	4 VDC or lower	60% (26.4 VDC)	
AJ35TC1-32DT *1	DC input (sink/source)	16	24 VDC	5 mA	500 V	17.5 VDC or higher	6 VDC or lower	100% (26.4 VDC)	

(1) Input specifications

(2) Output specifications

	Tune	No. of	Rated Load	Max. Load Current	Insulation	Max. Output Response Time		
Model	Туре	Points	Voltage	Max. Load Current	Withstand Voltage	OFF to ON	ON to OFF	
AX10Y10C	Relay output	16	24 VDC 240 VAC	2 A/pt, 4 A/com	1.5 KV	10 ms	12 ms	
AX10Y22C	Triac output	16	240 VAC	0.3 A/pt, 1.8 A/com	1.5 KV	1 ms	0.5 cycle + 1 ms	
AJ35TB1-16AR *2	Relay output	8	24 VDC 240 VAC	2 A/pt, 5 A/com	1.5 KV	10 ms	12 ms	
AX40Y10C	Relay output	16	24 VDC 240 VAC	2 A/pt, 5 A/com	1.5 KV	10 ms	12 ms	
AJ35TB1-16DR *2	Relay output	8	24 VDC 240 VAC	2 A/pt, 5 A/com	1.5 KV	10 ms	12 ms	
AJ35TB1-16DT *2	Transistor output	8	24 VDC	0.3 A/pt, 2.4 A/com	500 V	2 ms	2 ms	
AX40Y50C	Transistor output	16	12/24 VDC	0.3 A/pt, 3.6 A/com	500 V	2 ms	2 ms	
AX80Y10C	Relay output	16	24 VDC 240 VAC	2 A/pt, 4 A/com	1.5 KV	10 ms	12 ms	
AX80Y80C	Transistor output	16	24 VDC	0.5 A/pt, 4.8 A/com	500 V	2 ms	2 ms	
AJ35TC1-32DT *1	Transistor output	16	24 VDC	0.1 A/pt, 1.6 A/com	500 V	2 ms	2 ms	

For all models - Isolation type: photocoupler isolation, Input display: LED display *1: A 40-pin connector is used for external connection.

*2: Only usable with A2CJCPU-S3

Max. Resp	onse Time		Applicable Wire	Points/	Noise	Internal Current	No. of	Power
OFF to ON	ON to OFF	Field Wiring	Size	Common	immunity	Consumption (24 VDC)	Stations Occupied	Supply Requirement
15 ms	30 ms	Terminal		16	± 1.5 KV	0.074 A	4	
15 ms	30 ms	rminal		16	± 1.5 KV	0.116 A	4	
15 ms	30 ms	Terminal		8	± 1.5 KV	0.062 A	2	
10 ms	10 ms	Terminal		16	± 500 V	0.072 A	4	
10 ms	10 ms	Terminal	0.75 to 2 mm ² AWG14	8	± 500 V	0.062 A	2	
10 ms	10 ms	Terminal		8	± 500 V	0.061 A	2	SELV power
10 ms	10 ms	Terminal		16	± 500 V	0.074 A	4	supply is required
10 ms	10 ms	Terminal		16	± 500 V	0.072 A	4	
10 ms	10 ms	Terminal		16	± 500 V	0.082 A	4	
10 ms	10 ms	40-pin connector,Terminal	1	16	± 500 V	0.137 A	4	

	Applicable Wire	Points/	Surge	Fuse	Noise	External Power Supply			
Field Wiring	Size	Common	Suppression	Rating	immunity	Current	Requirement		
Terminal		8	None		± 1.5 KV	0.092 A	SELV power supply is required		
Terminal	•	8	CR		± 1.5 KV				
Terminal		8	None		± 1.5 KV	0.045 A			
Terminal		8	None		± 1.5 KV	0.092 A	SELV power supply is required		
Terminal	0.75 to 2 mm ² AWG 14	8	None		± 1.5 KV	0.045A			
Terminal		8	Zener diode		± 500 V				
Terminal		16	Zener diode		± 500 V	0.064 A			
Terminal	1	8	None		± 1.5 KV	0.092 A	SELV power		
Terminal] [16	Zener diode		± 500 V	0.010 A	supply is required		
40-pin connector,Terminal		16	Zener diode		± 500 V				

3. INSTALLATION

3.1 General Safety Requirements



This product is an open type equipment and itself doesn't comply with IP2X protection. The product must be installed in a suitable enclosure which should be selected and installed in accordance to the local and national standards.

An enclosure which contains the product can be opened only under any of the following conditions (a) to (c) in order to protect operators from electrical shock in normal operations. As the measure,

- (a) The use of a key or tool is necessary. This method is only allowed for access by skilled or instructed persons.
- (b) Disconnection of supplied power before the enclosure is opend.
- (c) Barriers should be provided for all live parts except those supplied by Extra-Low Voltage.

This products must be installed and used in environment specified as the environmental specifications. Otherwise, using in different environment could cause electrical shock, fire, malfunction, damage of the products and/or decrease of product capability.

Unsecured mounting of modules could cause malfunction, failure and/or fail-off of the modules.

Extension base cables must be securely connected. And make sure that no unsecured connection was made. Unsecured connection could cause PC to read and/or write wrong status from/to input or output modules.

A memory cassette module or memory chips must be securely loaded on a connector or socket. And make sure that no unsecured loading was made. Otherwise, unsecured loading could cause malfunction of the product.

3.2 Module Handling

- (1) Module enclosure, terminal block connectors and pin connectors are made of resin; do not drop them or subject them to strong impact.
- (2) Do not remove modules' printed circuit boards from the enclosure in order to avoid giving any changes.
- (3) During wiring, take care to ensure that wiring off-cuts, etc. do not get inside the case. If anything does get inside the case, remove it.
- (4) Tighten the module mounting and fixing screws as specified below.

Screw	Tightenig Torque N·cm (kg·cm) [lb·inch]
Module mounting screws (M4)	78.4 to 117.6 (8 to 12) [6.93 to 10.39]
I/O module terminal screw (M3.5)	58.8 to 88.2 (6 to 9) [5.2 to 7.79]
Power spply module terminal screws (M3.5)	83 to 113 (8.5 to 11.5) [7.37 to 9.95]

3.3 Unit Mounting

- (1) Unit mounting position
 - (a) To provide good ventilation and to make unit replacement easy, allow a clearance of 80 mm (3.15 inch) or over between the top side of the module and surrounding structures or parts.
 - (b) If the A2C I/O unit, A66PC or other unit is to be installed on the left side of the A2C, provide a clearance of 10 mm (0.39 inch) or over between them to allow Cover 1 to be opened and closed.



(2) Unit mounting orientation

Never install A2C units in the following environmental conditions.

- (a) Locations where ambient temperature is outside the range 0 to 55°C.
- (b) Locations where ambient humidity is outside the range of 10 and 90 % RH.
- (c) Locations where dew condensation takes place due to sudden temperature changes.
- (d) Locations where there are corrosive gasses and combustible gasses.
- (e) Locations where there is a high level of conductive powder such as dust and iron filings, oil mist, salt, and organic solvent.
- (f) Locations exposed to the direct rays of the sun.
- (g) Locations where strong power and magnetic fields are generated.
- (h) Locations where vibration and shock are directly transmitted to the main unit.
- (i) Installing A2C units
 - A2C and A2C I/O units can be installed vertically, horizontally or levelly.



Vertical installation







A2CJCPU (S3) installation horizontally

- (j) Install each unit on a flat surface.
 If the surface is uneven, an excess force may apply to printed circuit boards, causing malfunctioning.
- (k) Do not install the units together with or near such vibration sources as large-sized electromagnetic contactors and no-fuse breakers. Install them on a separate panel, or keep them away from the vibrating devices.
- (I) To avoid the effect of radiation noise or heat, keep the following distances between the units and devices (contactor, relay, etc.) which may generate radiation noise or heat:
 - Clearance in front of the units 100 mm (3.94 inch) or over
 - •Clearance on the right or left side of 50 mm (1.97 inch) or over the units



- (3) When using a DIN rail adapter, install a DIN rail in accordance with the following instructions.
 - (a) When installing a DIN rail TH35-7.5Fe or TH35-7.5AI

When installing DIN rails TH35-7.5Fe and TH35-7.5Al, fix the rails by screws every 200 mm (7.87 inch) or less. Fix the rails by screws every 100 mm (3.94 inch) or less to mount an A6DIN3C or to mount units side by side.



(b) When installing a DIN rail TH35-15Fe

When installing a DIN rail TH35-15Fe, fix the rails by screws every 200 mm (7.87 inch) or less.

Also, use the same intervals to mount an A6DIN3C or to mount units side by side.



P2 = 200 mm (7.87 inch) or less

3.4 Constructions to Reduce EMI Noise

The following measures are effective to reduce EMI noise generated by equipment which contains the A2C products.

(1) Grounding of a control cabinet

Material of the control cabinet should be steel or equivalent conductor so that radiation of noise is protected. However, if grounding of the cabinet is not good enough, the cabinet body to which noise is inducted becomes an antenna to radiate noise. Therefore, impedance of a grounding cable of the cabinet should be as low as possible. Use of a flat braided wire at shortest distance to the earth is recommended to minimize high frequency impedance.

Door of the cabinet should be also connected to the body by low impedance wires.

(2) Grounding of A2C

Please be aware of the following points for grounding of A2C.

- (a) Connect both LG and FG terminal on power supply modules to the control cabinet at shortest distance. Approx. 20 cm (7.87 in.).
- (b) Use thick wire for the earth connections. 2 mm^2 or thicker.
- (3) Process signal cables

Please be aware of the following points for process signal cable installations.

- (a) Do not install process signal cables with primary voltage lines.
- (b) If process signal cables are installed outside of the cabinet ,use of screen cables is effective for EMI noise reduction

3.5 Part Identification of the CPU

This section gives the names of each part of the CPU.

3.5.1 Names and settings of parts of the A2CCPU, A2CCPU-DC24V and A2CJCPU(S3)



			(13) Cover (10) (10) (12) (11) (11) (11) (11) (11) (11) (11) (11) (11) (11) (11) (11) (11) (11) (12) (11) (14) (8)(7)(9)(4)(3) (3) A2CJCPU (10) (12) (11) (12) (11) (12) (14) (8)(7)(9)(4)(3) (3) A2CJCPU (10) (12) (11) (12) (11) (12) (14) (8)(7)(9)(4)(3) (3) A2CJCPU (12) (14) (15) (14) (15) (14) (15) (14) (15) (14) (15) (14) (15) (14) (15) (14) (15) (14) (15) (14) (15) (14) (15) (14) (15) (14) (15) (14) (15) (15) (15) (14) (15) (15) (16) (17) (17) (14) (17) (14) (15) (15) (17) (14) (15) (15) (15) (15) (15) (16) (17) (16) (17) (17) (17) (16) (17) (17) (17) (16) (17) (17) (17) (16) (17					
No.	N	ame	Function					
(1)	RUN key swit	tch	• RUN/STOP : Used to start/stop running a sequence program.					
	-		• RESET : Used to reset the hardware. It resets an error which occurred during operation, and initializes the operation.					
			 L.CLR : Used to clear (turns OFF or sets to 0) the device in the latch and non-latch ranges which are set by parameters. Clear latching according to the following procedure: (1) Turn the RUN key switch from STOP to L.CLR several times to let the "RUN" LED flash. (2) Turn the RUN key switch from STOP to L.CLR again. (3) The "RUN" LED goes OFF, and latching is cleared. 					
(2)	Indicator		5 VDC power supply status indicator LED					
	LEDs	'POWER' LED	• ON : The 100/200 VAC or 24 VDC is supplied to the A2C, and converted into 5 VDC correctly.					
			• OFF : The 100/200 VAC or 24 VDC is not supplied to the A2C. Or, the supplied 100/200 VAC or 24 VDC is not converted into 5 VDC correctly.					
I			A2C run status indicator LED					
			ON : A sequence program operation is being executed with the RUN key switch set in the "RUN" position. (This LED remains ON if an error occurs, which permits the sequence program operation to continue.)					
		"RUN" LED	• OFF : This LED goes OFF if any of the following conditions exists: •The 100/200 VAC or 24 VDC is not supplied to the A2C. •The RUN key switch is in the "STOP" position. •A remote stop or remote pause signal exists.					
			 Flash This LED flashes if either of the following conditions exists: An error, which stopped the sequence program operation, has been detected by self-diagnosis. Latching is being cleared. 					
1			Self-diagnosis error detection status indicator LED					
		'ERROR' LED	• ON : An error has been detected by self-diagnosis. (This LED remains OFF when an error for which the indicator LED setting is OFF in the LED indication priority setting is detected.) Or, the MINI-S3 link is faulty.					
			• OFF : Normal					
			• Flash : The annunciator (F) is set ON by the sequence program.					

3. INSTALLATION

No.	N	ame	Function
(2)	Indicator LEDs		Data transmission status indicator LED (transmission to I/O modules and remote terminal modules)
		'SD' LED	• ON : The A2C is transmitting data to an I/O module or remote terminal module properly.
			 OFF : This LED goes OFF if any of the following conditions exists: The A2C does not transmit data to an I/O module or remote terminal module. Initial data or initial program error. A2C hardware fault
			Data receiving status indicator LED (receiving from I/O modules and remote terminal modules)
			• ON : The A2C is receiving data from an I/O module or remote terminal module.
		'RD' LED	 OFF : This LED goes OFF if any of the following conditions exists: The A2C does not receive data from an I/O module or remote terminal module. Disconnected cable to RDA or RDB or improper connection. Hardware trouble of the A2C, I/O module and/or remote terminal module.
(3)		connection to	• The terminals used to connect cables for communications with remote modules.
	remote modul	les	SDA : Connected to the RDA of the next station.
			SDB : Connected to the RDB of the next station.
			SG : Connected to the SG of the preceding and next stations.
			RDA : Connected to the SDA of the preceding station.
			RDB : Connected to the SDB of the preceding station.
			SLD : The shield of the shielded twisted-wire pair cable is connected.
			The following diagram shows the connections of the cables to the remote modules.
			* Connect both ends of the shield of the shielded twisted-wire pair cable wire pair cable
			Remote module A2C SDA SDA SDB SDB SDB SDB SDB SDB SDB SDB
(4)	ERR termina	1	 The output terminal to tell MINI-S3 link line troubles and self-diagnosis errors to the operator.
(5)	Power input	terminal	• The power input terminal used to connect the 100 VAC or 200 VAC power supply.
(6)	Operating vo switching ter		 Used to set the voltage to the power input terminal. When 100 VAC is applied: This terminal short-circuits the circuit between it and the input terminal with the attached jumper. When 200 VAC is applied: This terminal opens the circuit between it and the input terminal.
(7)	LG terminal		• Used to ground the power filter.
			Has an electric potential half the input voltage.

3. INSTALLATION

No.	Name	Function							
(8)	FG terminal	• The grounding terminal connected to the shielding pattern on the PC board.							
(9)	Power input terminal	• The power input terminal used to connect the 24 VDC power supply.							
(10)	Memory protect switch	 The switch used to protect the data in the user memory area from being rewritten (memory protect) due to wrong operation of peripheral devices. Data of 20k bytes from the head of the memory area can be protected by this function. 							
		To set memory protect To cancel memory protect							
		Memory protect switch Sw Sw							
	Memory selection switch	 The switch used to set the type of memory (A2C's internal RAM memory or EP-ROM) in which programs will be stored. Set the switch in the OFF position to use internal RAM memory. Set the switch in the ON position to use EP-ROM. 							
		Memory selection switch setting							
		To use internal RAM memory To use EP-ROM							
		Memory selection switch Sw Sw Sw Sw							
		• The socket used to install EP-ROM.							
(11)	Memory connection socket	• The socket used to filstall EF-nom.							
(11) (12)	Memory connection socket Battery connector	The connector used to connect the battery connector.							
12)	Battery connector	 The connector used to connect the battery connector. The battery used to retain data, such as programs, devices in the latch range, 							

3.5.2 Names and settings of parts of the A2CCPUP21/R21

This section describes names and settings of parts of the A2CCPUP21/R21 MELSECNET data link system.

The module has the same terminals, battery, RS-422 connector, and memory protect switch as the A2CCPU.

For details of these parts, refer to Section 3.5.1.



3. INSTALLATION

No.	Name	Description								
	Indicator LEDs	LEDs for indi	LEDs for indicating A2CCPUP21/R21 operation status and errors							
		LED Name	Description	LED Name	Description					
		L. RUN	Comes ON when the data link is normal.	1 POWER	Comes ON when the power is turned ON.					
		L. SD	Remains ON while data is sent.	*2 RUN	Comes ON when the RUN key switch is in the RUN position.					
:	E C C C C C C C C C C C C C C C C C C C	L. RD	Remains ON while data is received.	*3 ERROR	Comes ON when a PC CPU error occurs.					
	E O O SD MIN R CRC O O RD R OVER O O ABJE O O		Not used (aiways OFF)	*4 SD	Remains ON while data is sent in the MININET.					
	O AB.IF O O R TIME O O DATA O O F.LOOP	CRC	Comes ON when a code check error occurs.	*5 RD	Remains ON while data is received in the MININET.					
		OVER	Comes ON when a data entry delay error occurs.							
	R.LOOP 0 0 1 0 0 10	AB. IF	Comes ON when data is all "1".							
	20020	тіме	Comes ON when a time-out occurs.	L						
(15)	4 0 0 40 8 0 0 40	DATA	Comes ON when a receive data error occurs.	F.LOOP	Comes ON when the forward loop serves as the data receiving line, or goes OFF when the reverse loop is used for it.					
		UNDER	Comes ON when a send data error occurs.	CPU R/W	Comes ON during communications with the PC CPU.					
		F. LOOP	Comes ON when a forward loop receive data error occurs.							
		R. LOOP	Comes ON when a reverse loop receive data error occurs.							
		1	······································	10	Indicate the figures at the ten's					
		2	Indicate the figures at the one's	20	digit of the station numbers in BCD codes.					
		4	digit of the station numbers in BCD.	40						
		 B Refer to Section 2.4.1 for LEDs from *1 to *5. The LEDs other than *1 to *5 indicate the operation status of the MELSECNET 								
		data link. For details, refer to the MELSECNET (II) Data Link System Reference Manual.								
	Connectors	Connectors (or connecting optical fiber ca	bles						
		Connect th	ne cables as illustrated below	:						
					IN OUT					
(10)										
(16)										
	IN OUT Bave rea inco		· · ·	Lucros						
	Reverse loop Reverse loop send receive Forward loop Forward loop send									
		Ma	aster station Equipr	ment No.1	Equipment No.2					
	Connectors	Connectors	for connecting coaxial cables							
		Connect the second	ne cables as illustrated below	•						
					IN OUT					
			R-RD R-RD F-R	D OUT P-RD OUT F-SD	FRD RHD RSD V PLD					
(17)										
l	IN R-SD OUT R-RD	7								
l	Reverse loop eend									
	IN F-RD OUT F-SD Forward Forward bop series to bop series	N	Aster station Equip	ment No.1	Equipment No.2					

MELSEC-A

No.	Name	Description								
	Mode select switch	• By switching mode, the following functions are available:								
	MODE	Setting Number	Name	Description						
	180	0	Online	Automatic return is set during normal operation.						
	10 × 1 × 0	1	Online	Automatic return is not set during normal operation.						
	est to	2	Offline	The host station is disconnected.						
	× 10 3	3	Test mode 1	A test is performed on the forward loop lines of the whole data link system.						
		4	Test mode 2	A test is performed on the reverse loop lines of the whole data link system.						
(18)		5	Test mode 3	A test is performed on the line between two connected stations.						
		6	Test mode 4							
		7	Test mode 5	A test is performed by the A2CCPUP21/R21 alone on the hardware including the send/receive lines of the sending system.						
		8		Not used						
		9		Not used						
		A to C		Not used						
		D to F		Not used						
		For details of operations in the test modes, refer to the MELSECNET and MELSECNET/B Data Link System Reference Manual.								
	Station number setting	Station number se	etting switches							
	switches	• Station numbers from 00 to 64 can be set.								
	STATION No.									
	X10	•The "X10" switch is to set the ten's digit of a station number.								
(19)		•The "X1" switch is to set the one's digit of a station number.								
	200	 To use a stat 	ion as the ma	ster station, set "00".						
		•To use a station as a local station, set between "01" and "64".								

3.5.3 Names and settings of parts of the A2CCPUC24(-PRF)

This section describes names of parts of the A2CCPUC24(-PRF) computer link and switch settings.

The A2CCPUC24(-PRF) has the same terminals, battery, RS-422 connector, and memory protect switch as the A2CCPU.



Refer to Section 3.5.1.

3. INSTALLATION

No.	Name				Fu	nction	s and	Setting	8				
(20)	(20) Indicator LEDs		LED Name		lame LED Indication			ED Is ON	4	Whe	OFF	Initial State of LED	
		CPU	R/W	Com	munications with CPU			commu		s with C n.)	PU. (Ca	omes	ON
					Baud rate (BPS)	300	600	1200	2400	4800	9600	19200	The LED
		в0				OFF	ON	OFF	ON	OFF	ON	OFF	for the set baud
		B1	B1 Bau		rate setting	OFF	OFF	ON	ON	OFF	OFF	ON	rate is ON.
	L. RUN OO POWER	B2				OFF	OFF	OFF	OFF	ON	ON	ON	
	SD 0 0 RUN RD 0 ERROR Image: Straight of the straight of t	R S I 2	C/N		It of communications een RS-232C and CPU	proh the c the (compute CPU was essing th	was as made r link wł s runnin ne CPU i	aile g.	Normal	I		OFF
	- NAK 0 0 C/N - - NEU 0 0 P/S ACK 0 0 PRO	3 2 C	P/S	RS-2 error	32C parity/sum check	Parity/s	um che	ck error		Normal			OFF
	RS-422 NAK 0.0 SID		PRO	RS-2	32C protocol error	Commu	inicatior	protoco	ol error	Normal			OFF
	RS-485 SD 0 0 C/N - RD 0 0 P/S [RS-422]		sio	RS-2	32C SIO error	Overru	n/framin	g error		Normal			OFF
	□ RD 0 0 P/S RS-4222 CPU R/W 0 0 PR0 RS-425 B0 0 0 SIO □ B1 0 0 B2 0 0 PRT	R R S S I I 4 4	C/N		It of communications een RS-422/485 and	proh the c the C	compute CPU was essing th	was as made r link wh s running ae CPU i	ile 3.	Normal			OFF
		82 52	P/S		22/485 parity/sum k error	Parity/s	um cheo	ck error		Normal			OFF
			PRO	RS-4	22/485 protocol error	Commu	nication	protoco	error	Normai			OFF
			sio	RS-4	22/485 SIO error	Overrur	n/framin	g error		Normal			OFF
		PRT	•1	Printe	er message output		s ON du e outpu	ıring prin t.	nter	Normal			OFF

The indication and function indicated by *1 in the above table is peculiar to the A2CCPUC24-PRF.

- The right side LEDs from RS-232C C/N to RS-422/485 S10 come ON when an error occurs.
 Since the ON/OFF states of the C/N to the S10 are stored at buffer memory address 101H, the states can be confirmed by the sequence program by reading them with a FROM instruction from the CPU.
- (2) Once the LEDs from RS-232C C/N to RS-422/485 S10 come ON, they remain ON even after the normal state has been restored. To turn them OFF, a request to turn them OFF must be sent to buffer memory address 102H through a TO instruction from the CPU.
- (3) The initial state of LED means the state when turning ON the power or resetting the module.
- (4) The right side LEDs from "POWER" to "RD" are the same as those of the A2CCPU. Refer to Section 3.5.1. The states indicated by * vary according to the switch setting. Refer to the following table.

Mode Setting	1 to 4	5 to 8	9	A	F					
Main Channel Setting Name	RS-232C RS-422/485	RS-232C RS-422/485	RS-232C RS-422/485	RS-232C	RS-422 RS-485	RS-232C RS-422/485				
RS-232C-NEU	ON	OFF	OFF	ON	OFF	OFF				
RS-422/485-NEU	OFF	ON	OFF	OFF	ON	ON				
No.	Name	Functions and Settings								
------	--	---	--	--	--	--	--	--	--	--
(21)	RS-232C connector	The RS-232C connector for connection to computer or printer								
		Pin No. Signal S								
		1 CD Receive carrier detection 2 RD(RXD) Receive data								
		3● 8● 3 SD(TXD) Send data								
		5 90 4 DTR(ER) Data terminal ready								
		5 SG Signal ground								
		6 DSR(DR) Data set ready								
		7 RS(RTS) Request to send								
		8 CS(CTS) Clear to send								
		RS-232C connector specifications For details of signals, refer to the Computer Link/Multidrop Link Module User's Manual (Computer Link								
		Function/Printer Function). • The cap used to pull the cables from the RS-422/485 terminal block in the module.								
(22)	Rubber cap	Make a cut in the cap before using it.								
(23)	Station number setting switches	(1) Set station numbers between 0 and 31. (Do not use numbers 32 and up.)								
		(2) The "X10" switch is to set the ten's digit of a station number.								
	X10	(3) The "X1" switch is to set the one's digit of a station number.								
	k 5 € 5 € 1 0 2 0 8	 (4) Set station numbers between 0 and 31. Each number must not be used more than once. Stations need not be numbered sequentially from the first to the last connected to the computer. Some numbers can be skipped. (5) Example of station number setting: 								
		A2CCPUC24(-PRF)								
	$\begin{array}{c} X1 \\ k & 5 \\ m \\ c \\ c$	Computer Computer Station 0 Station 1 Station 31								
	The switches are factory-set to 0.	POINT								
		Do not assign a same number to one or more stations. If such a setting is made, communications data will be de- stroyed when data link operation is executed.								

No.	Name			Functions and Se	ttings
(24)	Mode setting switch	Setting Position	Se	etting	Remarks
		Number	RS-232C	RS-422/485	hemarks
		0	Unusable		
		1	Protocol 1 mode	No-protocol mode	
		2	Protocol 2 mode	No-protocol mode	These positions are used to print out the
		3	Protocol 3 mode	No-protocol mode	data in the no-protocol area of buffer memory by connecting two separate computers to the RS-232C and RS-422/485
	· · · · · · · · · · · · · · · · · · ·	4	Protocol 4 mode	No-protocol mode	interfaces or a printer to the no-protocol mode interface.
	MODE	5 •1	No-protocol mode	Protocol 1 mode	The RS-232C and RS-422/485 interfaces operate independently, but the transmission
	01894	6 *1	No-protocol mode	Protocol 2 mode	format is the same.
	0 (1) 0	7 *1	No-protocol mode	Protocol 3 mode	
	* 27 0	8 *1	No-protocol mode	Protocol 4 mode	
	~ · 0 3 3	9	No-protocol mode	No-protocol mode	This setting position is used to write data sent from a computer to all stations, or data from a station to a computer.
	These switches are factory-set to *0*.	A	Protocol 1 mode	Protocol 1 mode	
		В	Protocol 2 mode	Protocol 2 mode	These positions are used when a 1 : n- station computer link configuration is
		с	Protocol 3 mode	Protocol 3 mode	adopted. The RS-232C and the RS-422/485 interfaces function as a pair.
		D	Protocol 4 mode	Protocol 4 mode	
		E	Unusable		
		F	For self-loopback test		This position is used to check the A2CCPUC24(-PRF) to see if it functions properly without connecting a computer.
		The modes indic	ated by *1 (5 to 8) must	ttention to the following t be set when using the j an independent compute	printer function.

No.	Name	Functions and Settings											
(25)	Transmission specification setting	Owitch No.	ch No. Setting Item				Posi	tion and	Setting	;		c	P
	switches	Switch No.	Setting item	1		c	N		OFF			Ŭ	
:	ON OFF		Baud rate (BPS)	300	600	1200	2400	4800	9600	19200	Unus- able		
	SW	SW11		OFF	ON	OFF	ON	OFF	ON	OFF	ON	0	0
		SW12	Transmission speed (baud rate)	OFF	OFF	ON	ON	OFF	OFF	ON	ON		
	13	SW13		OFF	OFF	OFF	OFF	ON	ON	ON	ON		
		SW14	Data bit		8 b	its		7	bits			0	0
	16	SW15	Parity		Ch	ecked		N	lot chec	ked		0	0
		SW16	Even/odd parity		Ev	en		c	dd			0	0
		SW17	Stop bit		2 5	its		1	bit			0	0
		SW18	Sum check code		Ad	ded		N	lot adde	d	. in	0	x
		SW19	Main channel		RS	-422/RS	-485	F	18-2320			0	x
	These switches are factory-set to "OFF".	SW20	Write during RUN		En	abled		C	isabled			0	x
		The sam interface When se If used, t (2) Sum che When a (should b) Refer to is set to (3) Main cha is conner between When the The data the sub c When the The data channel.	annel setting (SW19) T cted. The main channel '9" and "D". In any m e main channel setting received by the main shannel is sent automa e mode setting switch other stations to the sic CPUC24(-PRF) execut CCCPUC24(-PRF)	RS-232C bled set	r both : ransmii all ope d protoc er's Ma chann g is val er than , data f is sen a positi n a re v cequest 22 Data fl 2/485 	with the second	ecificat combin will be c switch i text for s the co vhen the ve, this describ the the the the sting a Cl Cl Whe setting	ions. hation (S iisabled s used f mats an onnector e mode switch i ed belo by the s and "D they are and sen A2CCPL PU en the n enable	SW11, S to set w id sum of r (interfa setting may be w: ub chan p, the c. a receiv. ds proce JC24(-P	SW12, a hether a sheck of switch i in ON o anel, and omman- ed by th essing r RF)	a sum c' odes wh which a s set to r OFF p d the da ds to rec e main esult to	A are a heck co en this comput a position. ta rece position. ta rece the ma 32C Data 1 422/485	II ON). Ide switch er link ion ived by rocess- 1. in
(26)	Terminal resistance setting pins	processi	ng requested by an ex I resistance must be s	ternal de	evice w	hen the	CPU is	in the F	RUN sta	te.			





4. WIRING

4.1 General Safety Requirements

All external power supply must be turned off during installation and wiring. Unless all phases are cut off from the products, it could cause electrical shock or damage on the products.

Before connecting the power to the products, put terminal covers back onto the terminals.

Otherwise, it could cause electrical shock.

A protective earth terminal which is marked with " \bigoplus (LG)" must be connected to the earth.

Otherwise, it could cause electrical shock.

All electrical connections should be carried out by trained and competent personnel, and must comply with the requirements of all relevant local and national wiring regulations for installation wiring.

Particular attention is required when preparing the installation wiring for connection to terminal to ensure that hazardous live wiring are adequately separated from the Safety Extra Low Voltage wiring.

All external power supplies and signals connected to other devices or equipment, of which rated voltage is 24 V or lower, should not compromise the Safety Extra Low Voltage requirements.

A readily accessible switch or circuit breaker should be included in the equipment which contains the product so that the power supply for the product can be disconnected at any trouble.



CAUTION

Rated voltage and terminal assignment of each module should be confirmed before wiring is carried out. Connection of different voltage or wrong connection could cause fire and/or malfunction of the products.

Do not supply 24 VDC power supply from more than one power supply modules in parallel to one I/O moudle. If they are connected so, the power supply modules will be heated up and could be caused fire and/or malfunction.





Terminal screws should be tighten by the specified torque. Loose connection could cause short-circuit, fire and/or malfunction of the products.

During wiring, be sure that no off-cut of wires or other conductive dusts go into modules. It could cause fire, malfunction and/or failure of the products.

Wiring for modules which provide connector for external wiring should be securely carried out with the specified tools or by soldering. Unsecured connection could cause circuit-short, fire, and/or malfunction of the products.

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Do not place process control signal cables and/or communication cables nearby main power cables or actuation power cables so that risk of noise trouble can be minimized. It is recommended to keep a distance of 100 mm or more between those cables.

4.2 Power Supply Modules

(1) Terminal assignment



Terminal Name	Wiring Instructions
INPUT AC100/200V	Connect 100 to 120/200 to 240 VAC power supply wires to these terminals. Both of the terminal can be connected to either of hot or neutral line.
Short AC100 Open AC200	These are voltage selection terminal. Short the terminals for 100 to 120 VAC input, and open them for 200 to 240 VAC input.
LG	This is a functional earth terminal to be connected to the noise free earth. WARNING: If this terminal is not connected to the earth, the terminal holds half of the supplied voltage.
FG	This is a functional earth terminal to be connected to the noise free earth.
24V 24G	These are output terminals of 24 VDC service power which can be used as I/O load power and/or other purposes.

(a) A66PC

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(b) A2CJ66P



Terminal Name	Wiring Instructions
INPUT AC100/200V	Connect 100 to 120/200 to 240 VAC power supply wires to these terminals. Both of the terminal can be connected to either of hot or neutral line.
LG	This is a functional earth terminal to be connected to the noise free earth. WARNING: If this terminal is not connected to the earth, the terminal holds half of the supplied voltage.
FG	This is a functional earth terminal to be connected to the noise free earth.
24V 24G	These are output terminals of 24 VDC service power which can be used as I/O load power and/or other purposes.

- (2) Take following measures as much as possible so that risk of electrical noise problem is minimized.
 - (a) Provide separate wiring system for the PC power, I/O devices, and other operating devices as shown below. Further more, insert an isolated transformer if intensive noise is expected.



- (b) Power supply wires should be twisted as tightly as possible, and connect to power supply modules at the shortest distance. To minimize voltage drop, use wires as thick as possible.
- (c) As a measure against lighting surges, insert surge absorbers as shown below.



POINTS

- (1) Provide separator grounding for the lighting surge absorber (E1) and for the PC (E2).
- (2) Select a lighting surge absorber of which maximum allowable line voltage is higher than input voltage of the power supply module.

4.3 Digital I/O Modules

The following instructions should be observed for I/O module wiring.

- (1) I/O signal wires must be installed at least 100 mm (3.94 inch) away from high-voltage and large-current main power wires so that noise induction from such high power circuit is minimized.
- (2) If the I/O signal wires cannot be separately installed from the high power wires, use shielded cables for I/O signal and connect their shield to the earth.

4. WIRING

3

4.3.1 Input module connections

	1					
Model	Rated Input Voltage			Model	Rated Input Voltage	
(1) AX11C	100 to 120 VAC		(2)	AJ35TB1-16A	100 to 120 VAC	
AX21C	200 to 240 VAC					
24V • [16] and [2 [5] and [30 • DA	$\begin{array}{c} \text{RDA} & 1 & 26 & \text{SG} \\ \text{SG} & 2 & 27 & \text{SG} \\ \text{RDB} & 3 & 28 & \text{SL} \\ \text{RDB} & 3 & 28 & \text{SL} \\ \text{RDB} & 3 & 28 & \text{SL} \\ \text{SLD} & 4 & 29 & \text{Nc} \\ \text{+24V} & 5 & 30 & 42 & \text{SL} \\ $	$B = \frac{1}{2}$	* [19], [20], [21], [22] Iternally.	24 VDC - 249 24 VDC - 249 24 VDC - 249 SDA 3 RDA 4 SDB 5 RDB 6 RDB 6 FG 8 No connection 10 X00 11 X00 11 X00 11 X00 11 X00 11 X00 11 	re connected

4. WIRING





4.3.2 Output module connections



4. WIRING

	Model	Rated Input Voltage			Model	Rated Input Voltage		
(4)	AJ35TB1-16R	24 VDC/100 to 240		(5)	AY23C	100 to 240 VAC		
 	A3351B1-10A	+24V [1				J DA	
	24	VDC - 24G	2			SG 2 27 S	G	
		SDA	3			3 28	DB	
		RDA SDB	4			4 29 1	o connection 24V	
		RDB	5		24 VDC		lo connection	
		SG	7			Y00 / 32 Y	4G 10[_]	
		FG CTL+	8			[L YO1 9 34		
	24		9 10		•			
	г	<u> </u>	11		ļ	- <u>L</u> YO4 12 37	14[_]	
	•	L	12	1	+	- <u>L</u> <u>Y06</u> 13 38		
	t	Y03	13			Y07 15 40		
	Į	LY04	15		L			
	+	Y06	16					
	+	Y07	17					
	. 1	L COM1	18 19		•		1B 1C L	
	1		20			YOD 22 47	1D L	
		COM1 COM1	21		+	23 40		
	-	Y08	22 23		•			
	•		24	• [5] and [30], a	and [7] and [32] are co	nnected internally.	
	+		25					
	t		26 27			GER		
	ļ		28	Do			hile the power is	
	+	L YOE YOF	29	sup	plied.			
	t	COM2	30 31		Model	Rated Input Voltage		
		COM2	32	(6)	AY51C	12/24 VDC		
			33		1		 A	
			34			SG 2 27 SC		
	\land					RDB 3 28 St SLD 4 29 CT	1 <u>4</u>	
	DANGE				,	+24V 5 30 +2	4V 12/24 VDC	
		ermminals while	the power is		24 VDC		G	
sup	plied.				[24G 7 32 24 Y00 8 33 Y1		
						Y02 10 36 Y1	T T	
						L 703 11 36 TI		
					<u> </u>		5	ļ
ł						L 14 39 Y		
						COM 16 41 C	ж	
						Y06 17 42 Y1		
						- L YOA 19 44 Y		
						-L- 108 20 45 Y		
						L YOD 22 47		
i						YOE 23 48 Y		-
					I		DM4	
]	
				+ r/	1021 bne [and [7] and [32] are c	onnected internally	
					-j anu [30],	and [r] and [oz] are 0		_

Model	Rated Input Voltage		Model	Rated Input Voltage
(7) AY61CE	5/12/24 VDC	(8)	AY81C	24 VDC
	HDA 1 26 SDA SG 2 27 SG HDB 3 28 SDB SLD 4 29 No connection +24V 5 30 +24V FG 6 31 No connection 24G 7 32 24G Y00 8 33 Y10 Y01 9 34 Y11 Y02 10 35 Y13 Y03 11 36 Y14 Y04 12 37 Y15 Y05 13 38 Y15 Y06 14 39 Y17 COM 16 41 COM Y08 17 42 Y18 Y09 16 43 Y19 Y04 19 44 Y18 Y09 16 43 Y19 Y04 19 44 Y18 Y05 24 Y17 L Y04 19 44 <t< td=""><td></td><td></td><td>24 VDC RDA 1 26 SG RDB 2 27 SDB SLD 4 29 No connection +24V 5 30 CTL9 24G 7 32 Y10 Y00 8 33 Y11 L Y01 9 34 Y12 L Y03 11 36 Y13 L Y04 12 37 Y15 L Y06 13 38 Y18 L Y07 16 40 COM Y08 17 42 Y19 L Y08 17 42 Y19 L Y08 17 42 Y19 L Y09 18 43 Y1A L Y04 19 44 Y1B L Y09 18 43 Y1A L Y00 22 47 Y1D L Y02 21 46 Y1D L</td></t<>			24 VDC RDA 1 26 SG RDB 2 27 SDB SLD 4 29 No connection +24V 5 30 CTL9 24G 7 32 Y10 Y00 8 33 Y11 L Y01 9 34 Y12 L Y03 11 36 Y13 L Y04 12 37 Y15 L Y06 13 38 Y18 L Y07 16 40 COM Y08 17 42 Y19 L Y08 17 42 Y19 L Y08 17 42 Y19 L Y09 18 43 Y1A L Y04 19 44 Y1B L Y09 18 43 Y1A L Y00 22 47 Y1D L Y02 21 46 Y1D L
(9) Model	Rated Input Voltage	• [5 (10)] and [30], and [7 Model	7] and [32] are connected internally. Rated Input Voltage
(9) AJ35TB1A-8T	24 VDC		AJ35TB2-8T	5/12/24 VDC
	24G 1 +24V RDA 3 SDA RDB 6 5 FG 8 No connection comection 10 Y00 COM0 11 Y01 COM1 12 Y01 COM3 18 17 Y04 12 COM4 22 Y05 1 COM4 21 Y06 1 COM4 22 Y06 1 COM4 24 Y07 1			243 1 +24V RDA 3 SDA RDB 6 5 SDB RDB 6 7 VO 24V VO 24 G 9 YOO L COM 12 13 YO2 COM 16 17 YOU COM 16 17 YOU COM 18 19 YOU COM 22 1 YOU COM 28 YOT L
		• [9 interr], [12], [14], [16], nally.	, [18], [20], [22], [24], and [26] are connected

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	Model	Rated Input Voltage	(10)	Model	Rated Input Voltage	· ·
(11) -	AJ35TB1-16T	24 VDC	(12)	AJ35TB2-16T	24 VAC	
• [17]	24 VDC		• [9 in		+24V 1 24G 2 SDA 3 RDA 4 SDB 5 RDB 6 SG 7 FG 8 1/0 24V 9 4 VDC 1/0 24V 9 4 VDC 1/0 24V 9 1/0 24V 9 4 VDC 1/0 24V 9 1/0 24V 9 1/0 24V 9 1/0 24V 9 1/0 24V 9 1/0 24V 9 1/0 24G 10 12 10 13 10 12 13 16 10 12 10 13 16 10 10 11 COM 12 10 13 10 10 10 10 10 10 10 10 10 10	

(13) Model Rated Input Voltage	
AJ35TC1-32T 24 VDC	
24 VDC RDA 2 1 SDA RDB 6 5 SOB FG 8 7 SG	
Y00 B20 A20 Y10 L L Y01 B18 A19 Y11 L L Y02 B18 A18 Y12 L L Y03 B17 A17 Y13 L L Y04 B16 A16 Y14 L L Y06 B16 A16 Y14 L L Y06 B16 A16 Y14 L L Y06 B16 A16 Y17 L L Y06 B12 A12 Y18 L L Y07 B11 A11 Y19 L L Y08 B12 A12 Y14 L L Y08 B1 A11 Y18 L L Y08 B1 A11 Y14 L L Y08 B2 A9 Y18 L L Y07 B3 A5	
[A1] and [A2] are connected internally.	

4.3.3 Input/output composite module connections



	Model	Rated Input Voltage	Rated Load Voltage	_	Model	Rated Input Voltage	Rated Load Voltage
(4)	AX40Y10C	12/24 VDC	24 VDC/240 VAC	(5)	AJ35TB1-16DR	24 VDC	24 VDC/240 VAC
inter Do	ind [30], [7] and nally. DANGE	$\begin{array}{c c c c c c c c c c c c c c c c c c c $		Dc	DANGE not touch t pplied.	COM1 2 COM1 2 COM2 2 COM2 2 COM2 3 COM2 3	
(6)	Model	Rated Input Voltage	Rated Load Voltage	(7)	Model	Rated Input Voltage	Rated Load Voltage
(0)	AJ35TB1-16DT	24 VDC	24 VDC		AX40Y50C	12/24 VDC	12/24 VDC
		24 VDC - 246 	1 2 3 4 6 6 7 7 6 9 9 10 11 11 12 13 14 15 16 11 12 13 14 15 16 11 12 13 14 15 18 19 20 21 22 22 22 22 22 22 22 22 22 22 22 22		24 VDC	PDA 1 26 SDA SG 2 27 SG RDB 3 26 SDE SLD 4 25 STL+ +224V 5 30 +224V F6 6 31 CTLG 24G 7 32 246 0 X00 8 33 Y10 5 X01 9 34 Y12 L 5 X02 9 34 Y12 L 5 X03 11 36 Y13 L 5 X03 11 36 Y14 L 5 X04 12 37 Y14 L 5 X07 16 40 Y17 L 5 X07 16 40 Y17 L 5 X06 17 42 Y18 L 5 X06 12 46 Y18	are connected

4. WIRING

	Model	Rated Input Voltage	Rated Load Voltage		Model	Rated Input	Voltage	Rated Load Voltag	je
(8)	AX80Y10C	12/24 VDC	24 VDC/240 VAC	(10)	AJ35TC1-32DT	24 VDC		24 VDC	
[5] a inter (9)	AX80Y10C 24 VDC [24 VDC [12/24 VDC] 12/24 VDC] 12/24 VDC] 24 VDC [24 VDC] 12/24 V	12/24 VDC RDA 1 26 SDA SG 2 27 SDB SLD 3 28 SDL +24V 5 30 FCL +24V 5 30 FCL -4 29 CTL+ +24V 5 30 FCL -24G 6 31 24G -3 24G 7 32 24G -4 29 34 Y11 34 Y12 -5 X02 10 35 Y13 36 Y13 -5 X03 11 36 Y13 36 Y14 -5 X06 13 36 Y15 36 T15 40 Y17 -5 X06 17 42 Y18 Y14 X14 X14	24 VDC/240 VAC			24 VDC 24G 2 RDA 4 RDB 6 FG 8 - 0 X00 B20 - 0 X01 B19 - 0 X02 B18 - 0 X02 B18 - 0 X03 B17 - 0 X04 B19 - 0 X03 B17 - 0 X04 B19 - 0 X05 B15 - 0 X04 B19 - 0 X05 B15 - 0 X07 B13 COM1 B12 - 0 X07 B13 COM1 B12 - 0 X07 B13 COM1 B12 - 0 X07 B13 - 0 X	1 +24V 3 SDA 5 SDB 7 SG 7 SG 7 SG 7 SG 7 SG A19 X09 A19 X09 A117 X06 A12 X00 A14 X07 A15 X00 A14 X06 A12 CO A13 X06 A14 X07 A12 CO A13 X07 A14 X07 A3 X14 A3 X14 A4 X16 A4 X16 A2 CO A1 No		

5. FAIL-SAFE CONSTRUCTIONS

5.1 General Safety Requirements

Safety circuitry must be so designed and constructed externally that an entire system stays in safe in case of a external power supply failure and/or PC failure. In particular, the following safety circuitry are required to constructed outside of the PC.

- (1) Emergency stop circuit, protection circuit, interlocking circuit for contrary operations such as forward and reverse movement, and hardware stroke limit circuit for positioning controls must be constructed externally.
- (2) In case that hardware failure which PC CPU cannot detect occurs, all or some output signals could be turned on without program instructions. An external safety circuitry must be so constructed that safety of equipment or machine can be protected from such case. Please refer to Sub-clause 5.2 for details.
- (3) In some cases, relays or transistors used in output modules stay always ON or OFF as failure symptoms. If such failure could cause serious damage on persons or properties, those safety critical output signals must be externally monitored.

If the power to the PC is turned ON after turning ON the external power supply used for the process control with the DC output module, the DC output module may make an erroneous output for an instant. Take the following procedures for power up of the equipment, in order to prevent such erroneous input and output to/from the PC.

- (1) Turn ON the power to the PC.
- (2) Turn ON the external power supply used for the process control.
- (3) Turn ON the START switch.
- (4) Turn ON the power to the output devices by using a program.
- (5) Confirm that all external power supplies are turned ON, and then, an I/O control program should be executed.

5.2 Fail-Safe Circuitry Against to Failure of the PC

Though Mitsubishi PCs are manufactured under strict quality control, they may cause failure or abnormal operations due to unspecific reasons. To prevent the abnormal operation of the whole system, machine breakdown, and accidents, fail-safe circuitry against to failure of the PC must be constructed outside the PC.

The following page gives an example of system designing that conforms to the explanation mentioned above and an example of fail-safe measures when the PC causes a failure.

5. FAIL-SAFE CONSTRUCTIONS



(1) System design circuit example

AC/DC system

AC system

The procedures used to switch on the power supply are indicated below.

AC system

- [1] Switch the power supply ON.
- 2 Set the CPU to RUN.
- [3] Switch the start switch ON.
- [4] The output devices are driven in accordance with the program when the magnetic contactor (MC) comes ON.

AC/DC system

- [1] Switch the power supply ON.
- [2] Set the CPU to RUN.
- [3] Switch RA2 ON when establishment of the DC power supply starts.
- [4] Switch the timer (TM) ON when the DC power supply is 100% established.
 (The set value for TM must be the time it takes for 100% establishment of the DC power after RA2 is switched ON. Make this set value 0.5 seconds.)
- [5] Switch the start switch ON.
- [6] The output devices are driven in accordance with the program when the magnetic contactor (MC) comes ON.
 (If a voltage relay is used at RA2, no timer (TM) is necessary in the program.)

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Failure of a CPU or memory can be detected by the self diagnosis function. However, Failure of I/O control area may not be detected by the CPU. In such cases, all I/O points turn ON or OFF depending on a condition of problem, and normal operating conditions and operating safety cannot sometimes be maintained. Examples of fail-safe circuitry are described as follows:

(a) Using on-delay and off-delay timers



- *1: Y00 repeats turning ON and then OFF at 0.5 second intervals. Use a no-contact output module (transistor in the example shown above).
- (2) Countermeasure for momentary power failure to I/O units

Momentary power failure of the power supply to I/O units may cause incorrect input.

(a) Cause of incorrect input

I/O units have a DC-DC converter circuit to generate 5 VDC power from 24 VDC power supplied from the external.

Since internal 5 VDC holding time is longer than ON to OFF input response time, the A2C may be given incorrect input during the time signified by (A).



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(b) Prevention of incorrect input

Connect A66PC, A2CJ66P to a stabilized power supply and connect AC input to one same power supply.



Power Supply Wiring Example

6. MAINTENANCE

General Safety Requirement 6.1

DANGER

Maintenance activeties for the product should be carried out by trained and competent personnel.

Do not touch terminals while the power is supplied.

Cleaning or screw tightenig must be carried out while the power is off.



CAUTION

Do not change program, move switch of RUN, STOP of PAUSE, nor proceed force output during CPU RUN without confirmation of safety.

Do not disassemble nor modify the products.

Do not mount not dismount a module while the power is supplied.

Connect a battery properly. Do not recharge, disassemble, heat, burn, short, nor solder a battery.

Do not replace a battery other than A6BAT.

6.2 Daily Inspection

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It is recommended to inspect items listed in the follwing table to keep the equipment running without troubles.

No.	CI	heck Item	Check Point	Judgment	Corrective Action
1	Connecting condition		Check for loose terminal screws.	Screws should not be loose.	Retigten terminal screws.
			Check distance between solderless terminals.	Proper clearance should be provided between soldeness terminals.	Correct.
			Check connectors of extension cable.	connectors of be loose. extension	
2		"POWER" LED	Check that the LED is ON.	ON (OFF indicates an error.)	Refer to User's Manual
	sd	"RUN" LED Check that the LED is ON during RUN.		ON (OFF or flash indicates an error.)	Refer to User's Manual
	CPU module indicator lamps	'ERROR' LED	Check that the LED is ON when an error occurred.	OFF (ON when an error occurred.)	Refer to User's Manual
		Input LED Check t Dependence Dependence Check t LED tur and OF		ON when input is ON. OFF when input is OFF. (Display, which is not as mentioned above, indicates an error.)	Refer to User's Manual
	5 	Output LED	Check that the LED turns ON and OFF.	ON when output is ON. OFF when output is OFF. (Display, which is not as mentioned above, indicates an error)	Refer to User's Manual

6.3 Periodic Inspection

This section explains the inspection items which are to be checked every six months to one year. This inspection should also be performed when the equipment is moved or modified or the wiring is chaged.

No.	Check Item		Check Item Checking Method		Corrective Action	
1	nent	Ambient temperature	Measure with thermometer and hygrometer. Measure corrosive gas.	0 to 55 °C	When PC is used inside a panel, the	
	vironn	Ambient humidity		10 to 90 %RH	temperature in the panel is ambient temperature.	
	Ambient environment	Ambience	3	There should be no corrosive gases.		
2	Line	voltage	Measure voltage	85 to 132 VAC	Change supply	
	chec	:k.	across power supply input	170 to 264 VAC	power . Change transformer tap.	
			terminal of power supply unit.	15.6 to 31.2 VDC		
3	condition of each unit	Ingress of dust or foreign material	Visual check.	There should be no dust or foreign material, in the vicinity of the PC.	Remove and clean.	
4	ions	Loose terminal screws	Retighten.	Connectors should not be loose.	Retighten.	
	ତି betwe ଫୁ solder	Distances between solderless terminals.	Visual check.	Proper clearance should be provided between solderless terminals.	Correct.	
	Conn	Loose connector	Visual check.	Connectors should not be loose.	Retighten connector mounting screws.	
5	Battery		Check battery status by mounting special auxiliary relays M9006 and M9007. Retighten battery if necessary.	Preventive maintenance	If battery capacity reduction is not indicated, change the battery when specified service life is exceeded.	

6.4 Battery Replacement

A lithium battery is used in a CPU module to keep program and data during power failure time. When the voltage of battery comes low, M9006 and/or M9007 internal diagnostic signal come on. Please replace a battery as soon as possible once the signal is activated.

6.5 Fuse

Some of output modules have fuses on their output circuit. Aim of the fuses is not for protection of output modules themselves, but for protection of external wiring.

If a fuse is blown, it is expected that output devices on the module are damaged. And it is recommended to return the module to Mitsubishi representative for repair.

If an error occurs in the RUN mode, an error display or error code (including a step number) is stored in the special register by the self-diagnostic function.

The error code reading procedure and the causes of and corrective actions for errors are shown in Table 7.1.

7.1 Error Code List

Error Message	Content of Special Register D9008 (BIN value)	CPU States	Error and Cause	Corrective Action
'INSTRCT. CODE ERR' (Checked during instruction execution)	10	Stop	 Instruction code, which cannot be decoded by CPU, is included in the program. (1) ROM including invalid instruction code, has been loaded. (2) Memory contents have been corrected. (3) The PR and IRET instructions are used. 	 (1) Read the error step by use of peripheral device and correct the program at that step. (2) In the case of ROM, rewrite the contents of the ROM or change the ROM.
PARAMETER ERROR (Checked at power on, reset, STOP to RUN, PAUSE to RUN)	11	Stop	The parameter contents of CPU memory are changed due to noise or incorrect loading of memory.	 Check the loading of CPU memory and load it correctly. Read the parameter contents of CPU memory, check and correct the contents, and write them to the memory again.
"MISSING END INS." (Checked at STOP to RUN, PAUSE to RUN)	12	Stop	There is no END (FEND) instruction in the program.	Write END at the end of the program/subprogram.
CAN'T EXE- CUTE (P)* (Checked at [CJ], [SCJ], [JMP], [CALL(P)], [FOR to NEXT] execution,STOP to RUN, PAUSE to RUN)	13	Stop	 There is no jump destination or plural destinations specified by the [CJ], [SCJ], [CALL], [CALLP], or [JMP] instruction. Although there is no [CALL] instruction, the [RET] instruction exists in the program and has been executed. The [CJ], [SCJ], [CALL], [CALLP], or [JMP] instruction has been executed with its jump destination located below the END instruction. The number of [FOR] instruc- tions does not match that of [NEXT] instruction. The [JMP] instruction specified between [FOR to NEXT] has caused execution to deviate from between [FOR to NEXT]. 	Read the error by use of peripheral device and correct the program at that step. (Make correction such as the insertion of jump destination or the changing of jump destinations to one.)

Table 7.1 Error Code List

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Table 7.1 Error Code List (Continued)

Error Message	Content of Special Register D9008 (BIN value)	CPU States	Error and Cause	Corrective Action
CAN'T EXE- CUTE (P) (Checked at [CJ], [SCJ], [JUMP], [CALL (P)], [FOR to NEXT] execution, STOP to RUN, PAUSE to RUN)	13	Stop	 (6) The [JMP] instruction has caused execution to deviate from the subroutine before the [RET] instruction is executed. (7) The [JMP] instruction has caused execution to jump to a step or subroutine between [FOR to NEXT]. 	Read the error by use of peripheral device and correct the program at that step. (Make correction such as the insertion of jump destination or the changing of jump destinations to one.)
"CHK FORMAT ERR" (Checked at STOP to RUN and PAUSE to RUN)	14	Stop	 (1) There are instructions (including [NOP]) other than LDX, LDIX ANDX and ANIX in the [CHK] instruction circuit block. (2) There is more than one [CHK] instruction. (3) The number of contact points in the [CHK] instruction circuit block exceeds 150. (4) The X device number in the [CHK] instruction circuit block exceeds X1FE. (5) There is not (6) D1 device (number) of the [CHKID1ID2] instruction is different from the contact device (number) above the CJ[] instruction. (7) Pointer P254 is not attached to the start of the [CHK] instruction circuit block. 	Check the program of the [CHK] instruction circuit block for (1) to (6) in the left column. Correct errors using a peripheral device and start operation again.
"ROM ERROR" (Checked at power on and reset)	17	Stop	 Parameters and sequence pro- grams are not correctly written to installed EP-ROM. EP-ROM is destroyed. 	Replace EP-ROM with another EP- ROM to which parameters and sequence programs are correctly written.
MEMORY PROTECT ERROR (Checked at power on and reset)	18	Stop	The MEMORY PROTECT switch is set in the ON position while operating the A2C system using ROM stored programs.	Set the MEMORY PROTECT switch in the OFF position.

Table 7.1 Error Code List (Continued)

Error Message	Content of Special Register D9008 (BIN value)	CPU States	Error and Cause	Corrective Action
"RAM ERROR" (Checked at power on, reset, M9084 ON during STOP)	20	Stop	The CPU has checked if write and read operations can be performed properly to the data memory area of CPU, and as a result, either or both has not been performed.	Since this is CPU hardware error, consult Mitsubishi representative.
OPE. CIRCUIT ERR." (Checked at power on and reset)	21	Stop	The operation circuit, which performs the sequence processing in the CPU, does not operate properly.	
"WDT ERROR" (Checked at the execution of END instruction)	22	Stop	 Scan time exceeds watch dog error monitor time. (1) Scan time of user program has become excessive. (2) Scan time has lengthened due to Momentary power failure which occurred during scan. 	 Calculate and check the scan time of user program and reduce the scan time by use of [CJ] in- struction, etc. Monitor the content of special register D9005 by use of per- ipheral device. When the con- tent is other than 0, line voltage is insufficient. Therefore, check the power and eliminate the vol- tage fluctuation.
"END NOT EXECUTE" (Checked at the excution of END instruction)	24	Stop	 When the [END] instruction is executed, another instruction code has been read due to noise, etc. The [END] instruction has cha- nged to another instruction code for some reason. 	Perform reset and run. If the same error is displayed again, it is the CPU hardware error. Therefore, consult Mitsubishi representative.
•WDT ERROR• (Checked continuously)	25	Stop	The CPU is executing an endless loop. example: P0 JMP P0	Switch the CPU to STOP and reset it with the RUN key switch. Check the position of JMP, CJ and SCJ in the program and the pointer (P).
CONTROL BUS ERR (for A2CCPUC24 (REF))	40	Stop	FROM/TO instructions cannot be executed. (1) An error occurred in the control bus to the computer link.	There is a hardware fault in the A2CCPUC24(-PRF). Replace the module and check the faulty module. Consult your nearest Mitsubishi representative.
"SP. UNIT DOWN" (for A2CCPUC24 (REF))	41	Stop	 When a FROM/TO instruction is executed no response comes back from the computer link. (1) The accessed computer link is faulty. 	There is a hardware fault in the A2CCPUC24(-PRF). Consult your nearest Mitsubishi representative.
'I/O INT EROR' (for A2CCPUC24 (REF))	43	Stop	Although the computer link did not make a request, a request was generated in the CPU.	There is a hardware fault in the A2CCPUC24(-PRF). Consult your nearest Mitsubishi representative.

Table 7.1 Error Code List (Continued)

Error Message	Content of Special Register D9008 (BIN value)	CPU States	Error and Cause	Corrective Action
SP. UNIT LAY ERR. (for A2CCPUC24 (PRF))	44	Stop	Initial communications could not be made with the computer link.	There is a hardware fault in the A2CCPUC24(-PRF). Consult your nearest Mitsubishi representative.
SP. UNIT ERROR (Checked at the execution of FROM and TO instructions)	46	Stop	The [FROM/TO] instructions were executed for the station (1 to 61) which was not designated by the initial setting.	 Perform initial setting of the stations which is designated by the [FROM/TO] instructions. Change the station number designated by the [FROM/TO] instructions.
LINK PARA. ERROR (Checked at power on, reset, STOP to RUN, and PAUSE to RUN) (for A2CCPUP21/R21)	47	Run	 Data written to a link parameter area specified by parameter setting of a peripheral device is different from data read by the CPU for some reason. Number of total slave stations is set at 0. 	 Perform parameter setting and operate again. If the same error is displayed again, it is a hardware error. Consult Mitsubishi representa- tive.
"OPERATION ERROR" (Checked at instruction execution)	50	Run (Stop)	 The result of BCD conversion has exceeded the specified range (9999 or 99999999). Setting has been performed exceeding the specified device range and operation cannot be performed. File registers are used in the program without performing the capacity setting of file registers. Station designation of the [FROM/TO] instructions is 0 or over 62. 	Read the error step by use of per- ipheral device, and check and correct the program at that step. • Device setting range • BCD conversion value • Parameter setting for file re- gisters • Station number designated by the [FROM/TO] instructions
BATTERY ERROR (Checked continuously (Not checked when M9084 is on)	70	Run	 (1) The battery voltage has re- duced to less than the speci- fied value. (2) The battery lead is discon- nected. 	 (1) Change the battery. (2) When RAM or power failure compensation is used, connect the battery.

IMPORTANT

- (1) Design the configuration of a system to provide an external protective or safety inter locking circuit for the PCs.
- (2) The components on the printed circuit boards will be damaged by static electricity, so avoid handling them directly. If it is necessary to handle them take the following precautions.
 - (a) Ground your body and the work bench.
 - (b) Do not touch the conductive areas of the printed circuit board and its electrical parts with non-grounded tools, etc.

Under no circumstances will Mitsubishi Electric be liable or responsible for any consequential damage that may arise as a result of the installation or use of this equipment.

All examples and diagrams shown in this manual are intended only as an aid to understanding the text, not to guarantee operation. Mitsubishi Electric will accept no responsibility for actual use of the product based on these illustrative examples.

Owing to the very great variety in possible applications of this equipment, you must satisfy yourself as to its suitability for your specific application.

type A2CCPU(P21/R21), A2CCPU-DC24V, A2CCPUC24(-PRF), A2CJCPU(S3)

User's Manual (Hardware)

MODEL A2CPU(H/W)-U-E

13JE62

MODEL CODE

IB(NA)66475-D(0810)MEE

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